

PS9122

1 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP (SO-5), HIGH-SPEED PHOTOCOUPLER R08DS0256EJ0100 Rev.1.00 Dec 2, 2021

DESCRIPTION

The PS9122 is an optical coupled high-speed, active low type isolator containing an AlGaAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9122 is a high-speed digital output type photocoupler designed specifically for low circuit current.

The PS9122 is in 5-pin plastic SOP (Small Outline Package) and is suitable for high density application.

FEATURES

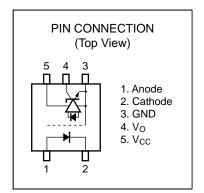
Supply Voltage
 N rank: Vcc = 3.3 V
 L rank: Vcc = 5 V

- Pulse width distortion (| tphl tplh | = 200 ns MAX.)
- Small package (SO-5)
- High-speed (1 Mbps)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Open collector output
- Embossed tape product: PS9122-F3: 2 500 pcs/reel
- Pb-Free product
- Safety standards

• UL : UL1577, Single protection

• CSA : CAN/CSA-C22.2 No.62368-1, Basic insulation

• VDE : DIN EN 60747-5-5 (Option)



APPLICATIONS

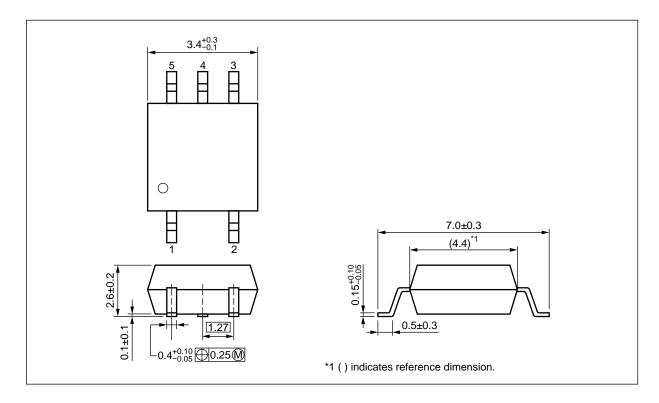
- PoE (Power over Ethernet)
- Measurement equipment
- FA Network

TRUTH TABLE

| LED | Output |
|-----|--------|
| ON | L |
| OFF | Н |

Start of mass production Oct.2008

PACKAGE DIMENSIONS (UNIT: mm)

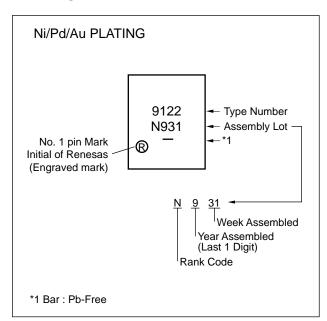


Weight: 0.08g (typ.)

PHOTOCOUPLER CONSTRUCTION

| Parameter | Unit (MIN.) |
|-------------------------|-------------|
| | ` ' |
| Air Distance | 4.2 mm |
| | |
| Outer Creepage Distance | 4.2 mm |
| Isolation Distance | 0.2 mm |

MARKING EXAMPLE



ORDERING INFORMATION

| Part Number | Order Number *4 | Rank | Solder Plating Specification | Packing Style | Safety Standards Approval | Application Part Number *1 |
|-------------|-----------------|------------|------------------------------------|------------------------------|------------------------------|----------------------------------|
| PS9122 | PS9122-AX | N*2 L*3 | Pb-Free (Ni/Pd/Au) | 20 pcs (Tape 20 pcs cut) | Standard products (UL, CSA | PS9122 |
| PS9122-F3 | PS9122-F3-AX | N*2 L*3 | | Embossed Tape 2 500 pcs/reel | approved) | |
| PS9122-V | PS9122-V-AX | N*2 L*3 | | 20 pcs (Tape 20 pcs cut) | UL, CSA, DIN EN 60747-5-5 | |
| PS9122-V-F3 | PS9122-V-F3-AX | N*2 L*3 | | Embossed Tape 2 500 pcs/reel | approved | |

Notes*: 1. For the application of the Safety Standard, following part number should be used.

N rank: Vcc = 3.3 V
 L rank: Vcc = 5 V

4. When specifying rank, please add "/rank" after Order Number.

ex. N rank: PS9122-AX/N

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

| | Parameter | Symbol | Ratings | Unit |
|---------------------|----------------------|------------------|--------------|---------|
| Diode | Forward Current *1 | lF | 25 | mA |
| | Reverse Voltage | VR | 5 | V |
| Detector | Supply Voltage | Vcc | 7 | V |
| | Output Voltage | Vo | 7 | V |
| | Output Current | lo | 20 | mA |
| | Power Dissipation *2 | Pc | 40 | mW |
| Isolation V | oltage *3 | BV | 3 750 | Vr.m.s. |
| Operating | Ambient Temperature | TA | - 40 to +100 | °C |
| Storage Temperature | | T _{stg} | - 55 to +125 | °C |

Notes*: 1. Reduced to 0.17 mA/°C at $T_A = 25$ °C or more.

- 2. Applies to output pin Vo (collector pin). Reduced to 1.5 mW/ $^{\circ}$ C at T_A = 80 $^{\circ}$ C or more.
- 3. AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

RECOMMENDED OPERATING CONDITIONS

| Parameter | | Symbol | MIN. | TYP. | MAX. | Unit |
|--|--------|-----------------|------|------|------|------|
| Low Level Input Voltage | | V _{FL} | 0 | | 0.8 | ٧ |
| High Level Input Current | | lғн | 6.3 | 10 | 12.5 | mA |
| Supply Voltage | N rank | Vcc | 2.7 | 3.3 | 3.6 | ٧ |
| | L rank | | 4.5 | 5.0 | 5.5 | |
| TTL ($R_L = 1 \text{ k}\Omega$, loads) | | N | | | 3 | |
| Pull-up Resistor | | R _L | 330 | | 4 k | Ω |

ELECTRICAL CHARACTERISTICS 1: N rank ($T_A = -40$ to +100 °C, unless otherwise specified)

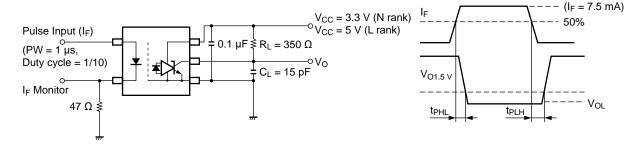
| | Parameter | Symbol | Conditions | MIN. | TYP.*1 | MAX. | Unit |
|----------|---|------------------|---|------------------|--------|------|-------|
| Diode | Forward Voltage | VF | IF = 10 mA, TA = 25 °C | | 1.6 | 1.8 | V |
| | Reverse Current | l _R | VR = 3 V, TA = 25 °C | | | 10 | μА |
| | Terminal Capacitance | Ct | V = 0 V, f = 1 MHz, T _A = 25 °C | | 30 | | pF |
| Detector | High Level Output Current | Іон | Vcc = Vo = 3.3 V, V _F = 0.8 V | | 1 | 100 | μА |
| | Low Level Output Voltage*2 | Vol | $Vcc = 3.3 \text{ V}, I_F = 5 \text{ mA}, I_{OL} = 10 \text{ mA}$ | | 0.2 | 0.6 | V |
| | High Level Supply Current | Іссн | Vcc = 3.3 V, I _F = 0 mA, Vo = Open | | | 2 | mA |
| | Low Level Supply Current | Iccl | Vcc = 3.3 V, I _F = 10 mA, Vo = Open | | | 3 | |
| Coupled | Threshold Input Current $(H \rightarrow L)$ | IFHL | $Vcc = 3.3 \text{ V}, Vo = 0.8 \text{ V}, R_L = 350 \Omega$ | | 2 | 5 | mA |
| | Isolation Resistance | Rı-o | V _{I-O} = 1 kV _{DC} , RH = 40 to 60 %, T _A = 25 °C | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | C _{I-O} | V = 0 V, f = 1 MHz, T _A = 25 °C | | 0.6 | | pF |
| | Propagation Delay Time $(H \rightarrow L)^{*3}$ | t PHL | $\label{eq:Vcc} \begin{aligned} \text{Vcc} &= 3.3 \text{ V, RL} = 350 \ \Omega, \text{ If} = 7.5 \text{ mA}, \\ \text{VthhL} &= \text{VthLH} = 1.5 \text{ V} \end{aligned}$ | | | 500 | ns |
| | Propagation Delay Time (L → H)*3 | tрLH | | | | 700 | |
| | Rise Time | tr | | | 60 | | ns |
| | Fall Time | tf | | | 70 | | |
| | Pulse Width Distortion (PWD)*3 | tphl-tplh | | | | 200 | ns |
| | Common Mode Transient Immunity at High Level Output* ⁴ | СМн | $\label{eq:Vcc} \begin{aligned} &\text{Vcc} = 3.3 \text{ V, R}_{\text{L}} = 350 \Omega, \text{ T}_{\text{A}} = 25 ^{\circ}\text{C}, \\ &\text{I}_{\text{F}} = 0 \text{ mA, Vo} > 2.0 \text{ V, V}_{\text{CM}} = 1.0 \text{ kV} \end{aligned}$ | 15 | 20 | | kV/μs |
| | Common Mode Transient Immunity at Low Level Output* ⁴ | СМ∟ | $Vcc = 3.3 \text{ V}, \text{ R}_L = 350 \ \Omega, \text{ T}_A = 25 \ ^{\circ}\text{C},$ $I_F = 7.5 \text{ mA}, \text{ Vo} < 0.8 \text{ V}, \text{ V}_{CM} = 1.0 \text{ kV}$ | 15 | 20 | | |

ELECTRICAL CHARACTERISTICS 2: L rank ($T_A = -40$ to +100 °C, unless otherwise specified)

| | Parameter | Symbol | Conditions | MIN. | TYP.*5 | MAX. | Unit |
|----------|---|------------------|---|------------------|--------|------|-------|
| Diode | Forward Voltage | VF | I _F = 10 mA, T _A = 25 °C | | 1.6 | 1.8 | V |
| | Reverse Current | IR | VR = 3 V, TA = 25 °C | | | 10 | μА |
| | Terminal Capacitance | Ct | V = 0 V, f = 1 MHz, T _A = 25 °C | | 30 | | pF |
| Detector | High Level Output Current | Іон | Vcc = Vo = 5 V, VF = 0.8 V | | 1 | 100 | μА |
| | Low Level Output Voltage*6 | Vol | Vcc = 5 V, I _F = 5 mA, I _{OL} = 13 mA | | 0.2 | 0.6 | V |
| | High Level Supply Current | Іссн | Vcc = 5 V, I _F = 0 mA, Vo = Open | | | 2.5 | mA |
| | Low Level Supply Current | Iccl | Vcc = 5 V, I _F = 10 mA, Vo = Open | | | 3.5 | |
| Coupled | Threshold Input Current $(H \rightarrow L)$ | IFHL | $Vcc = 5 \text{ V}, Vo = 0.8 \text{ V}, R_L = 350 \Omega$ | | 2 | 5 | mA |
| | Isolation Resistance | Rı-o | VI-o = 1 kVpc, RH = 40 to 60 %, TA = 25 °C | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | C _{I-O} | V = 0 V, f = 1 MHz, T _A = 25 °C | | 0.6 | | pF |
| | Propagation Delay Time $(H \rightarrow L)^{*7}$ | t PHL | $\label{eq:Vcc} \begin{aligned} &\text{Vcc} = 5 \text{ V, } \text{RL} = 350 \Omega \text{, } \text{If} = 7.5 \text{ mA,} \\ &\text{VTHAL} = \text{VTHLH} = 1.5 \text{ V} \end{aligned}$ | | | 500 | ns |
| | Propagation Delay Time $(L \rightarrow H)^{*7}$ | t PLH | | | | 700 | |
| | Rise Time | tr | | | 60 | | ns |
| | Fall Time | tf | | | 70 | | |
| | Pulse Width Distortion (PWD)*7 | tphl-tplh | | | | 200 | ns |
| | Common Mode Transient Immunity at High Level Output*8 | СМн | $\label{eq:Vcc} \begin{aligned} &\text{Vcc} = 5 \text{ V, } \text{RL} = 350 \Omega\text{, } \text{TA} = 25 ^{\circ}\text{C}\text{,} \\ &\text{IF} = 0 \text{ mA, } \text{Vo} > 2.0 \text{ V, } \text{Vcm} = 1.0 \text{ kV} \end{aligned}$ | 15 | 20 | | kV/μs |
| | Common Mode Transient Immunity at Low Level Output*8 | CML | $Vcc = 5 \text{ V, } R_L = 350 \Omega, \text{ T}_A = 25 ^{\circ}\text{C},$ $I_F = 7.5 \text{ mA, } Vo < 0.8 \text{ V, } VcM = 1.0 \text{ kV}$ | 15 | 20 | | |

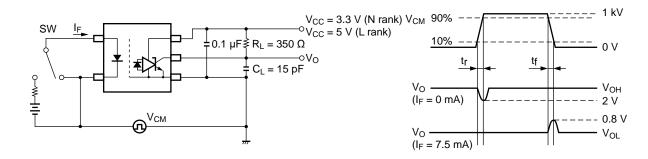
Notes*: 1,5. Typical values at $T_A = 25$ °C.

- 2,6 . Because VoL of 2 V or more may be output when LED current input and when output supply of Vcc = 2 V more or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device
- 3,7. Test circuit for propagation delay time



Remark: C_L includes probe and stray wiring capacitance.

4,8. Test circuit for common mode transient immunity

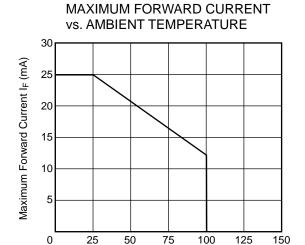


Remark: C_L includes probe and stray wiring capacitance.

USAGE CAUTIONS

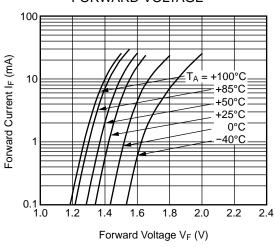
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than $0.1\mu F$ is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.
- 4. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 5. Do not use fixing agents or coatings containing halogen-based substances.

TYPICAL CHARACTERISTICS (T_A = 25 °C unless otherwise specified)

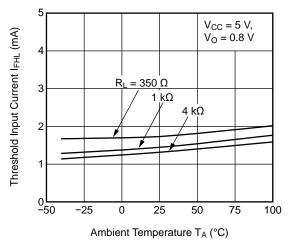


FORWARD CURRENT vs. FORWARD VOLTAGE

Ambient Temperature T_A (°C)

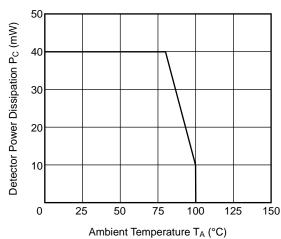


THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

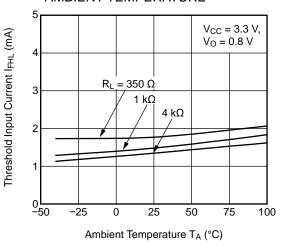


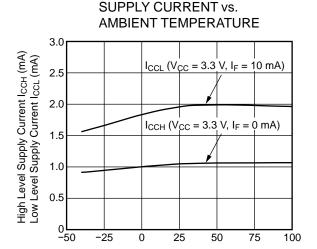
Remark The graphs indicate nominal characteristics.

DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

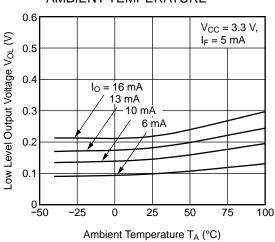




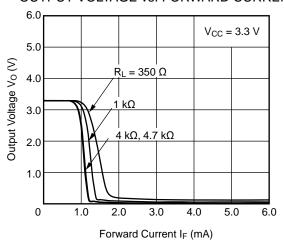


Ambient Temperature T_A (°C)

100

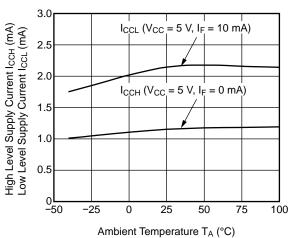


OUTPUT VOLTAGE vs. FORWARD CURRENT

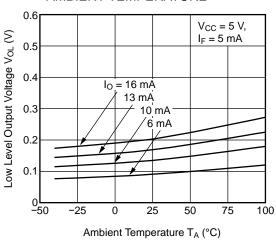


Remark The graphs indicate nominal characteristics.

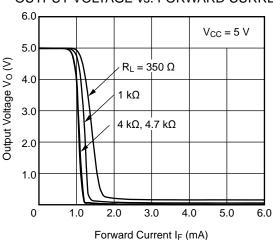
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



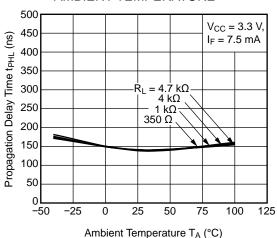
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



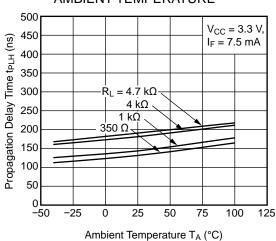
OUTPUT VOLTAGE vs. FORWARD CURRENT



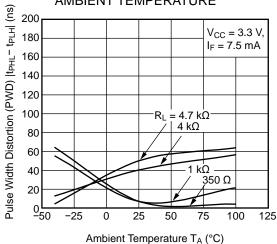
PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



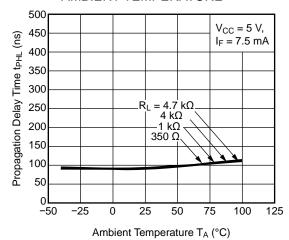
PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



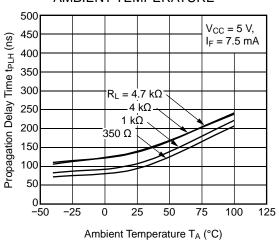
PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



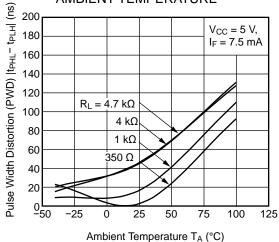
PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



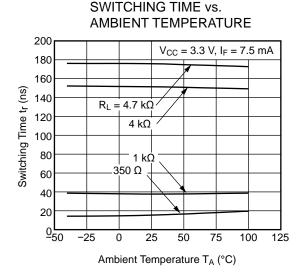
PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



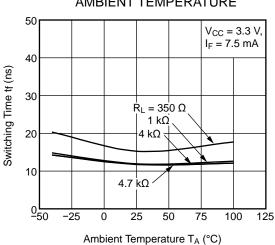
PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



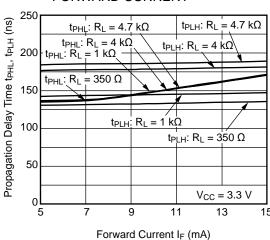
Remark The graphs indicate nominal characteristics.



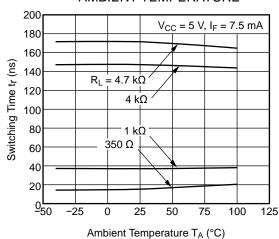




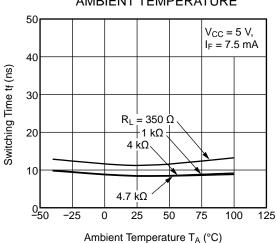
PROPAGATION DELAY TIME vs. FORWARD CURRENT



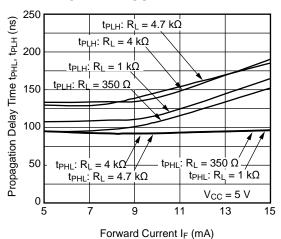
SWITCHING TIME vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. AMBIENT TEMPERATURE



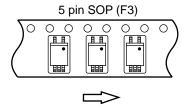
PROPAGATION DELAY TIME vs. FORWARD CURRENT



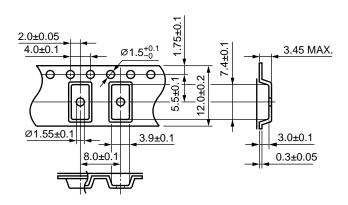
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

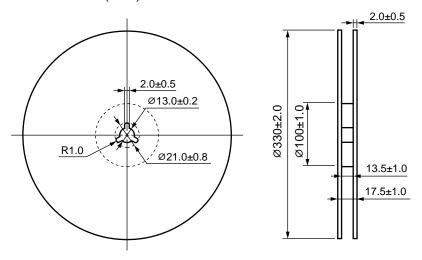




Outline and Dimensions (Tape)

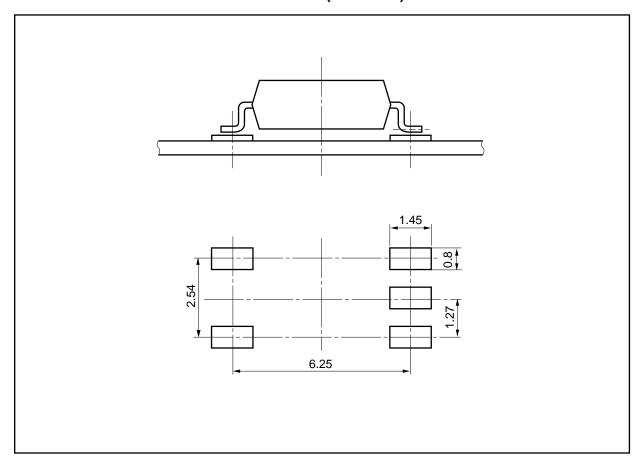


Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

• Flux

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

Peak reflow temperature
 260 °C or below (package surface temperature)

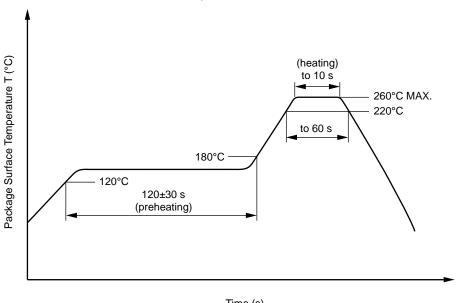
Time of peak reflow temperature
 Time of temperature higher than 220 °C
 10 seconds or less
 60 seconds or less

• Time to preheat temperature from 120 to 180 °C $\,$ 120 \pm 30 s

• Number of reflows Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260 °C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120 °C or below (package surface temperature)

Number of times
 Flux
 One (Allowed to be dipped in solder including plastic mold portion.)
 Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350 °C or below
 Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100 °C
- (4) Cautions
 - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

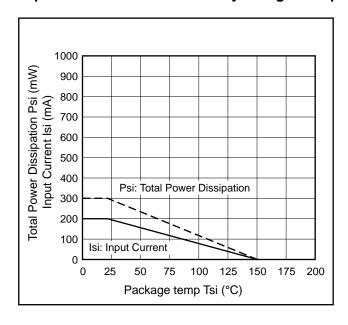
2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

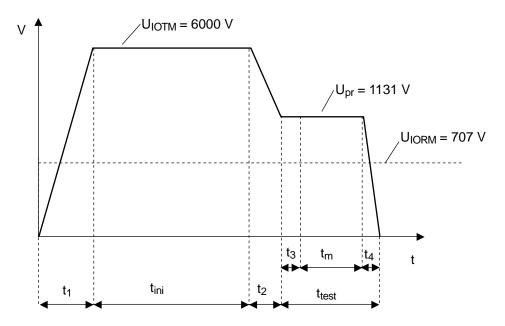
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Rating | Unit |
|--|----------------------|--------------------------------------|-------------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 40/100/21 | |
| Dielectric strength maximum operating isolation voltage | U _{IORM} | 707 | V_{peak} |
| Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM.}, \ P_d < 5 \ pC$ | U_pr | 1 131 | V_{peak} |
| Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM.}, P_d < 5 \; pC$ | U_pr | 1 326 | V _{peak} |
| Highest permissible overvoltage | Uютм | 6 000 | V_{peak} |
| Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)) | | 2 | |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11)) | CTI | 175 | |
| Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)) | | III a | |
| Storage temperature range | T_{stg} | - 55 to +125 | °C |
| Operating temperature range | T _A | - 40 to +100 | °C |
| Isolation resistance, minimum value $V_{IO} = 500 \text{ V}$ dc at $T_A = 25 \text{ °C}$ $V_{IO} = 500 \text{ V}$ dc at T_A MAX. at least 100 °C | Ris MIN. Ris MIN. | 10 ¹² 10 ¹¹ | Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) | | | |
| Package temperature | Tsi | 150 | °C |
| Current (input current I _F , Psi = 0) | Isi | 200 | mA |
| Power (output or total power dissipation) Isolation resistance | Psi | 300 | mW |
| V _{IO} = 500 V dc at T _A = Tsi | Ris MIN. | 10 ⁹ | Ω |

Dependence of maximum safety ratings with package temperature



Method a) Destructive Test, Type and Sample Test



 t_1 , $t_2 = 1$ to 10 sec

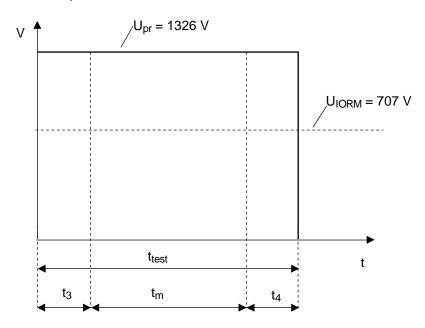
 $t_3, t_4 = 1 sec$

 $t_{m(PARTIAL\ DISCHARGE)} = 10\ sec$

 $t_{test} = 12 \text{ sec}$

 $t_{ini} = 60 \text{ sec}$

Method b) Non-destructive Test, 100% Production Test



 t_3 , $t_4 = 0.1 \text{ sec}$

 $t_{\text{m(PARTIAL DISCHARGE)}} = 1.0 \text{ sec}$

 $t_{\text{test}} = 1.2 \text{ sec}$

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or i any way allow it to enter the mouth.

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